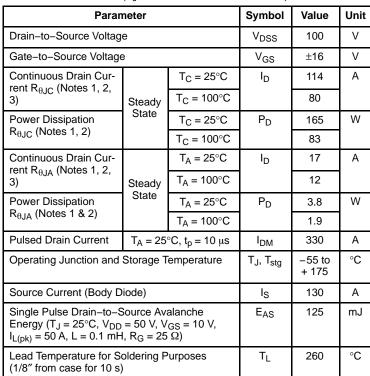
## **Power MOSFET** 100 V, 8.0 mΩ, 114 A, Single N–Channel

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- NVMFS6B05NWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)



Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{ extsf{ heta}JC}$	0.9	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{ extsf{ heta}JA}$	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

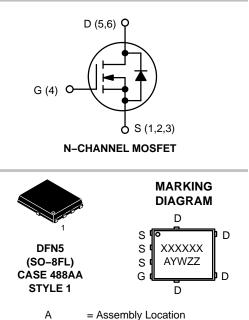
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
100 V	8.0 mΩ @ 10 V	114 A



Y = Year W = Work Week

ZZ = Lot Traceability

#### **ORDERING INFORMATION**

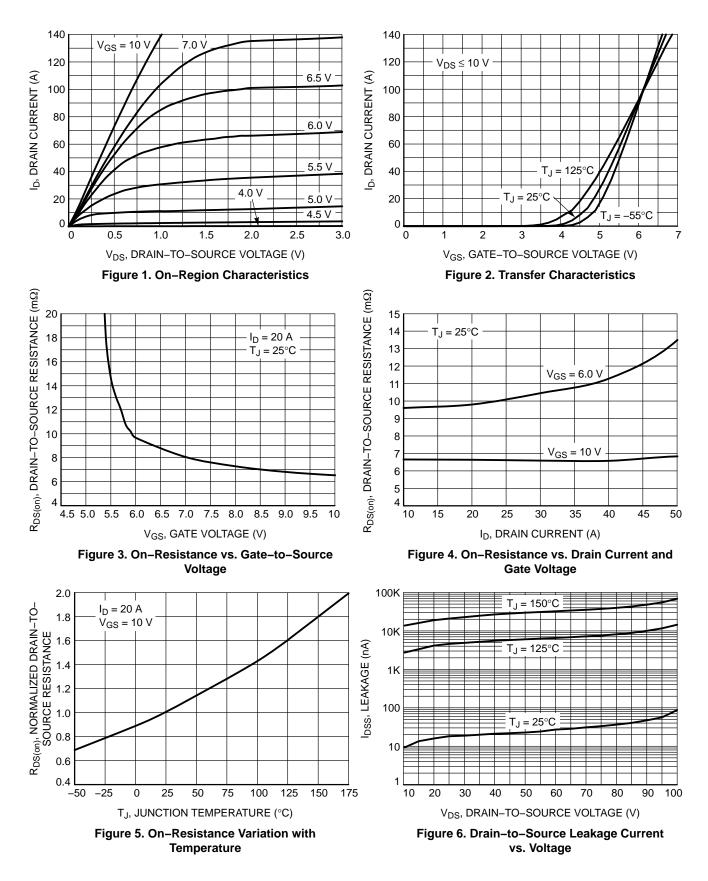
See detailed ordering, marking and shipping information on page 5 of this data sheet.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

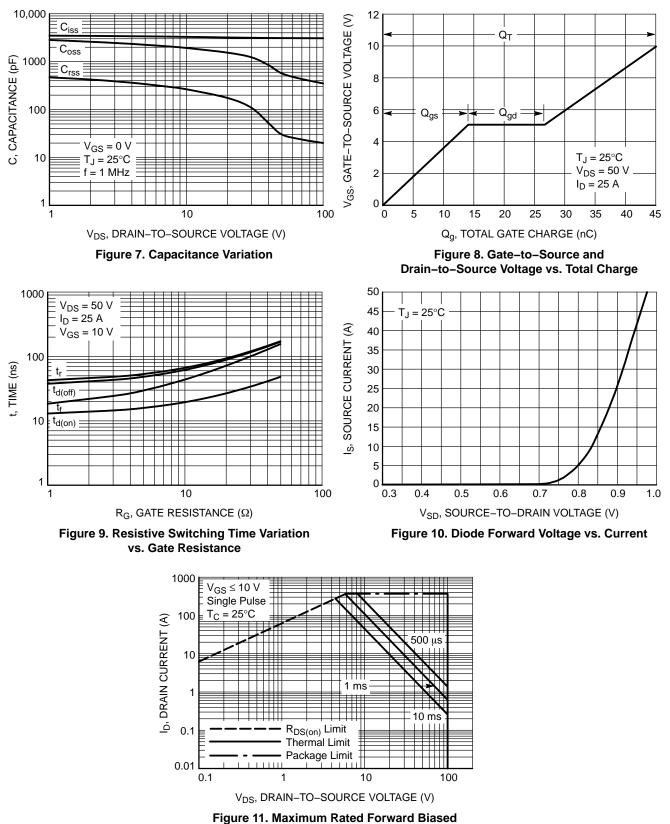
Parameter	Symbol	Test Cond	ition	Min	Тур	Мах	Unit
OFF CHARACTERISTICS				-	-	-	-
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$		100			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				72.8		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{PQ} = 80 V$	$T_J = 25^{\circ}C$			10	
			T <sub>J</sub> = 125°C			100	μA
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 16 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D$	= 250 μA	2.0		4.0	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				7.91		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A		6.5	8.0	mΩ
CHARGES, CAPACITANCES & GATE RESIS	STANCE		-	-	-	-	-
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 25 V			3100		pF
Output Capacitance	C <sub>OSS</sub>				570		
Reverse Transfer Capacitance	C <sub>RSS</sub>				28		
Total Gate Charge	Q <sub>G(TOT)</sub>				44		1
Threshold Gate Charge	Q <sub>G(TH)</sub>				5.0		1
Gate-to-Source Charge	Q <sub>GS</sub>	$V_{GS} = 10 \text{ V}, V_{DS} = 50 \text{ V}; I_D = 25 \text{ A}$ $T_J = 25^{\circ}\text{C}$			14		nC
Gate-to-Drain Charge	Q <sub>GD</sub>				12		
Plateau Voltage	V <sub>GP</sub>				5.0		V
Gate Resistance	R <sub>G</sub>				1.0		Ω
SWITCHING CHARACTERISTICS (Note 5)							
Turn-On Delay Time	t <sub>d(ON)</sub>				14		
Rise Time	t <sub>r</sub>	$\begin{array}{l} V_{\mathrm{GS}} = 10 \; V,  V_{\mathrm{DS}} = 50 \; V, \\ I_{\mathrm{D}} = 25 \; A,  R_{\mathrm{G}} = 1.0 \; \Omega \end{array}$			43		ns
Turn-Off Delay Time	t <sub>d(OFF)</sub>				39		
Fall Time	t <sub>f</sub>				16		
DRAIN-SOURCE DIODE CHARACTERISTIC	s						
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 25 A	$T_J = 25^{\circ}C$		0.9	1.2	v
			T <sub>J</sub> = 125°C		0.8		
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dIS/dt = 100 A/µs, I <sub>S</sub> = 25 A			58		ns
Charge Time	ta				30		
Discharge Time	t <sub>b</sub>				28		
Reverse Recovery Charge	Q <sub>RR</sub>				83		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width  $\leq 300 \,\mu$ s, duty cycle  $\leq 2\%$ . 5. Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**



#### **TYPICAL CHARACTERISTICS**



Safe Operating Area

#### **TYPICAL CHARACTERISTICS**

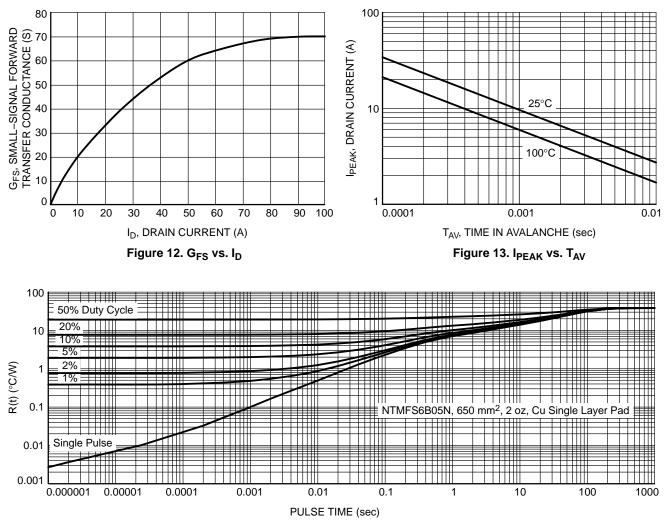


Figure 14. Thermal Response

#### **DEVICE ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
NVMFS6B05NT1G	6B05N	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS6B05NWFT1G	6B05WF	DFN5 (Pb–Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS6B05NT3G	6B05N	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS6B05NWFT3G	6B05WF	DFN5 (Pb–Free, Wettable Flanks)	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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